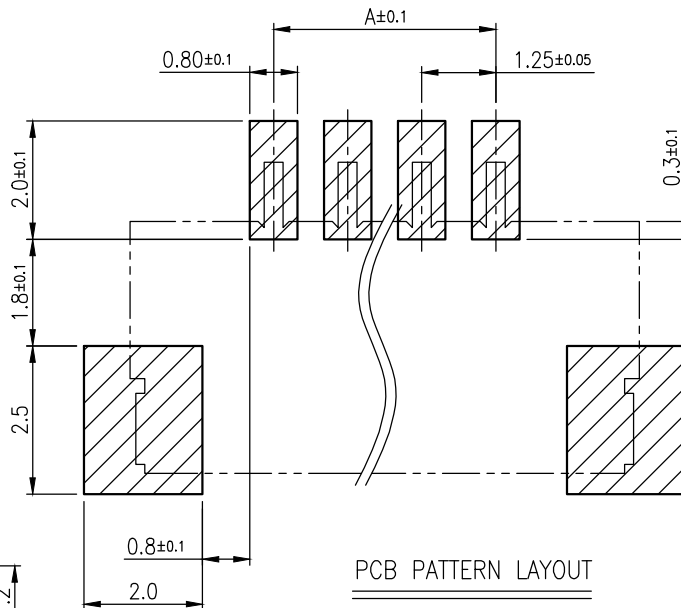
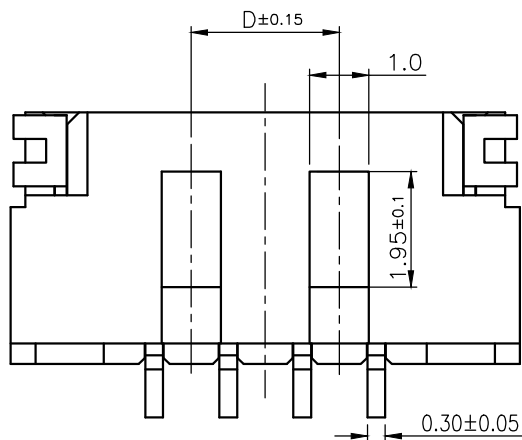
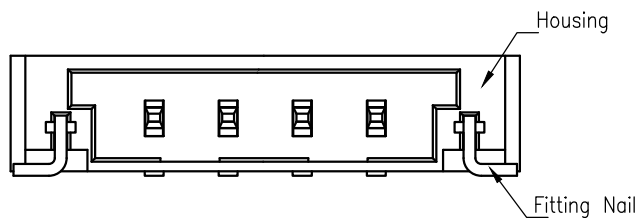
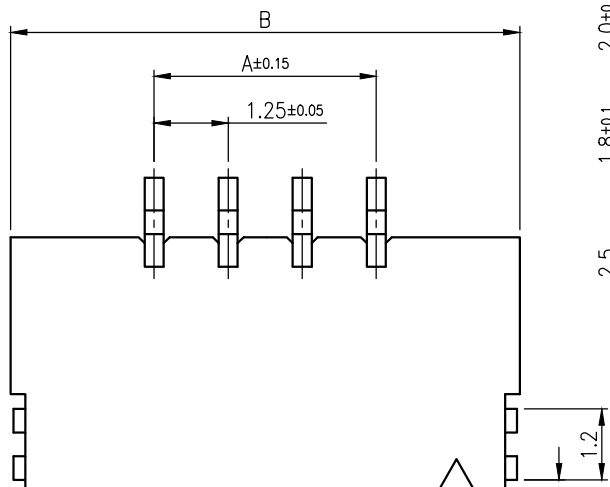
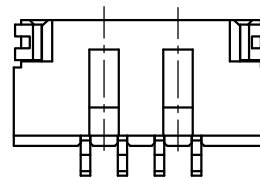


THE BOTTOM OF 2~3P



THE BOTTOM OF 4~30P

NOTES:

1. MATERIAL:

- 1.1 HOUSING: HALOGEN FREE PLASTIC, UL94V-0.
- 1.2 CONTACT: COPPER ALLOY
- 1.3 FITTING NAIL: COPPER ALLOY

2. PLATING:

2.1 TERMINAL:

2.1.1 CONTACT AREA

- 50u" NICKEL OVERALL,
L: 120u" MIN. LEAD-FREE (PURE TIN).
1: GOLD FLASH PLATING.
N: 120u" MIN. MATTE TIN PLATING.

2.1.2 SOLDER AREA

- 50u" MIN. NICKEL OVERALL,
N: 100u" MIN. MATTE TIN PLATING.

2.2 FITTING NAIL:

- 50u" MIN. NICKEL OVERALL,
N: 120u" MIN. MIN. MATTE TIN PLATING.

3. REFLOW SOLDER CAPABLE TO 260°C PER ACES SPEC.

4. SPEC. PLS. REFER TO PS-50281-XXXX-XXX

5. PACKAGE PLS. REFER TO 88266-XXXX-TRP

6. PART NUMBER

P/N LEGEND

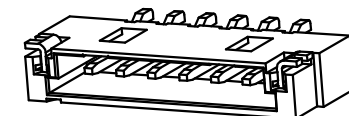
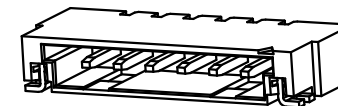
51288-XXX X X-XXX

NO OF CKT
PACKING
0: TAPE & REEL

XXX	Housing Color
001	Black

PLATING

N: MATTE TIN
1: G/F over all



CKT	Dim A	Dim B	Dim D
6	6.25	11.10	5.00

QUALITY SYMBOLS MAJOR CRITICAL	DRAWN BY YANJINXIU 22/03/15	DATE 22/03/15	ACES ELECTRONICS TITLE 1.25mm WTB LPF Header SMT R/A S/R Type
GENERAL TOLERANCES (UNLESS SPECIFIED)	CHECKED BY XUZHUYONG 22/03/15	DATE 22/03/15	
X. ±0.5 .X ±0.25 .XX ±0.15 .XXX ±0.1 ANGLES ±2°	UNITS mm	SCALE 1:1	
	SHEET NO. 1 OF 1	REV B	
			RFG NO. N/A
			DWG NO. 51288-XXXX-XXX